505389717 03/22/2019

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5436510

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
CHOONGHYUN LEE	03/19/2019
INJO OK	03/14/2019
SHOGO MOCHIZUKI	03/14/2019
SOON-CHEON SEO	03/14/2019

RECEIVING PARTY DATA

Name:	International Business Machines Corporation		
Street Address:	New Orchard Road		
City:	Armonk		
State/Country:	NEW YORK		
Postal Code:	10504		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16362040

CORRESPONDENCE DATA

Fax Number: (203)878-2481

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2038777961

Email: mchang@MJC-IPLaw.com

MICHAEL J. CHANG **Correspondent Name:** Address Line 1: **84 SUMMIT AVENUE** Address Line 2: MICHAEL J. CHANG, LLC

Address Line 4: MILFORD, CONNECTICUT 06460

NAME OF SUBMITTER: MICHAEL J. CHANG /Michael J. Chang/ DATE SIGNED: 03/22/2019 This document serves as an Oath/Declaration (37 CFR 1.63).	ATTORNEY DOCKET NUMBER:	P201700416US01
DATE SIGNED: 03/22/2019	NAME OF SUBMITTER: MICHAEL J. CHANG	
	SIGNATURE: /Michael J. Chang/	
This document serves as an Oath/Declaration (37 CFR 1.63).	DATE SIGNED:	03/22/2019
1	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 4

PATENT REEL: 048675 FRAME: 0642

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PATENT REEL: 048675 FRAME: 0643

DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of Invention: BIPOLAR JUNCTION TRANSISTOR (BJT) WITH 3D WRAP AROUND EMITTER

As a below named and undersigned inventor, I hereby declare that:							
This declaration is directed	to the attac	hed appl	ication,	or (if folk	owing box is	checked):	
[] United States application	n or PCT in	ternation	nal appli	cation nu	mber	filed on	
The above-identified applic	cation was n	nade or a	uthorize	d to be m	ade by me.		
I believe that I am the original application.	nal inventor	r or an or	iginal jo	int invent	or of a claime	ed invention in th	
I have reviewed and unders	tand the cor	ntents of	the appl	ication, in	cluding the c	laims.	
I am aware of the duty to d known to me to be material							tion

Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document;

Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a corporation of New York having a place of business at Armonk, New York, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by the ASSIGNEE, its successors, legal representatives, or assigns.

Page 1 of 2

I acknowledge my prior and ongoing obligations to sell, assign, and transfer my rights under this Assignment to the ASSIGNEE and am unaware of any reason why I may not have the full and unencumbered right to sell, assign, and transfer my rights hereby sold, assigned, and transferred, and have not executed, and will not execute, any document or instrument in conflict herewith. I also hereby grant the ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

(1)	Legal Name of	Inventor: Choonghyu,	n Lee			
	Signature:	Choong)	n Lee	a managan kan kan kan kan kan kan kan kan kan k	Date: 3/	19/2019
(2)	Legal Name of	Inventor: Injo Ok				
	Signature:				Date:	
(3)	Legal Name of	Inventor: Shogo Moci	nizuki			
	Signature:		-communication in the state of		Date:	······································
(4)	Legal Name of	Inventor: Soon-Cheor	i Seo			
	Signature:				Date:	

DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of Invention: BIPOLAR JUNCTION TRANSISTOR (BJT) WITH 3D WRAP AROUND EMITTER

As a below named and undersigned inventor, I nereby declare that:
This declaration is directed to the attached application, or (if following box is checked):
[] United States application or PCT international application number filed on
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the contents of the application, including the claims.
I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR Section 1.56.

Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document;

Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a corporation of New York having a place of business at Armonk, New York, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by the ASSIGNEE, its successors, legal representatives, or assigns.

Page 1 of 2

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I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

(1) Legal Name of Inventor: Choonghyun Lee

Signature:	Date:
(2) Legal Name of Inventor: Injo Ok	
Signature:	Date: 3/14/2019
(3) Legal Name of Inventor: Shogo Mochizuki	
Signature:	Date: 3/14/2019
(4) Legal Name of Inventor: Soon-Cheon Seo	
Signature:	Date: 3/14/2019

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